



REV.	ECN NO OR DESCRIPTION	REVISED	DATE
E	ECN NO.C100561 MODIFY DIMENSION	PENG	2010.11.26
F	ECN NO:C110149-14 Modify Plating specification	BILLY	2011.06.09
G	ECN NO:C140074 MODIFY LAYOUT	ZLS	2014.7.28
H	ECN NO:S170227-C	JIE-FU	2017.03.20

SPECIFICATIONS:

- ELECTRICAL CHARACTERISTICS:**
 - 1-1. RATING: 36V AC, 1A DC.
 - 1-2. CONTACT RESISTANCE: 50mΩ MAX.
 - 1-3. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
 - 1-4. INSULATION RESISTANCE: 100MΩ MIN. MEASURED BY 500 VDC
- MECHANICAL CHARACTERISTICS:**
 - 2-1. INSERTION FORCE : 0.4~3.0 KGF
 - 2-2. WITHDRAWAL FORCE : 0.3~2.0 KGF
- LIFE TEST: 5,000 CYCLES MIN.**
- OTHER GENERAL SPEC. TO REFER "2SJ2285 SERIES SPEC".**
- TO CONFORM TO THE SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.**
- HALOGEN FREE PRODUCT IDENTIFICATION MARK ON JACK:**
- HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING:**
- FOR REFLOW SOLDERING LEAD-FREE PROCESS.**
- PACKAGING: TAPE&REEL.**

NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
I	MYLAR	1	MYLAR 0.75T	
H	SHELL	1	COPPER ALLOY 0.20T	Nickel Plated
G	TRANSFER TERMINAL	1	COPPER ALLOY 0.20T	△ Gold Flash on contact area and Solder tail,all over Nickel Plated
F	MAKE TERMINAL	1	COPPER ALLOY 0.20T	GOLD FLASH
E	RING	1	COPPER ALLOY 0.20T	△ Gold Flash on contact area and Solder tail,all over Nickel Plated
D	SHUNT	1	COPPER ALLOY 0.20T	GOLD FLASH
C	TIP	1	COPPER ALLOY 0.25T	△ Gold Flash on contact area and Solder tail,all over Nickel Plated
B	EARTH	1	COPPER ALLOY 0.20T	GOLD FLASH
A	BODY	1	HIGH TEMP.THERMOPLASTIC UL 94V-0	BLACK
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
UNLESS OTHERWISE SPECIFIED TOLERANCES		Singatron Enterprise Co., Ltd. 信音企業股份有限公司		
DECIMALS:	ANGLES:	TITLE 3.5 3 POLE PHONE JACK		
X : ±0.5	X : ±2°	DWN	JIE-FU	PART NO. 2SJ2285-001191
X.X : ±0.3	X.X : ±1°	CHKD	CERRY	SCALE 3:1 UNIT: mm
X.XX : ±0.2		APVD	LUSSSEN	SIZE: A3 SHEET: 10F1 REV: H
CUSTOMER COPY				